## IN THE CLAIMS

## Please amend the claims as follows:

- 1. (Original) Plasma doping apparatus comprising:
- a plasma doping chamber;
- a platen mounted in said plasma doping chamber for supporting a workpiece, said workpiece constituting a cathode;
- a source of ionizable gas coupled to said chamber, said ionizable gas containing a desired dopant for implantation into the workpiece;
  - an anode spaced from said platen;
- a pulse source for applying high voltage pulses between said platen and said anode for producing a plasma having a plasma sheath in the vicinity of said workpiece, said plasma containing positive ions of said ionizable gas, said high voltage pulses accelerating said positive ions across the plasma sheath toward said platen for implantation into the workpiece; and
- a Faraday cup positioned adjacent to said platen for collecting a sample of said positive ions accelerated across said plasma sheath, said sample being representative of the number of positive ions implanted into the workpiece.
- (Original) Plasma doping apparatus as defined in claim 1 further comprising means for maintaining said Faraday cup and said platen at substantially equal electrical potentials.
- 3. (Original) Plasma doping apparatus as defined in claim 1 further comprising an electrically conductive mask having an opening aligned with said Faraday cup and means for maintaining said mask and said platen at substantially equal electrical potentials.

Serial No.: 09/836,743

Docket No.: VSEA 97-003

4. (Original) Plasma doping apparatus as defined in claim 1 wherein an entrance to said

Faraday cup is substantially coplanar with the workpiece.

5. (Original) Plasma doping apparatus as defined in claim 1 wherein said Faraday cup

comprises a plurality of Faraday cups disposed around said platen.

6. (Original) Plasma doping apparatus as defined in claim 1 wherein said Faraday cup

comprises an annular Faraday cup disposed around said platen.

7. (Original) Plasma doping apparatus as defined in claim 1 further comprising a guard

ring disposed around said platen, wherein said Faraday cup is positioned within said guard ring.

8. (Original) Plasma doping apparatus as defined in claim 1 further comprising a guard

ring disposed around said platen, wherein said Faraday cup comprises a plurality of Faraday cups

positioned within said guard ring, and further comprising means for maintaining the Faraday

cups at the same potential as the guard ring to suppress capacitive contribution to the measured

current.

9. (Original) Plasma doping apparatus as defined in claim 1 further comprising a guard

ring disposed around said platen, wherein said Faraday cup comprises an annular Faraday cup

positioned within said guard ring, and further comprising means for maintaining the annular

Faraday cup at the same potential as the guard ring to suppress capacitive contribution to the

measured current.

10. (Original) Plasma doping apparatus as defined in claim 1 wherein said Faraday cup

generates an electrical current representative of the number of positive ions implanted into the

workpiece per unit time and wherein said apparatus further comprises a dose processing circuit

for integrating said current with respect to time and generating an output representative of the

dose of positive ions implanted into the workpiece.

11. (Original) Plasma doping apparatus as defined in claim 1 wherein said Faraday cup

comprises a plurality of Faraday cups disposed around said platen, each producing a current

representative of the number of positive ions implanted into the workpiece per unit time and

wherein said plasma doping apparatus further comprises a dose uniformity circuit for comparing

the currents produced by said plurality of Faraday cups and generating in response to the

comparison an output indicative of the uniformity of ion implantation into the workpiece.

12. (Original) Plasma doping apparatus as defined in claim 1 further comprising an

electrode positioned at an entrance of said Faraday cup and means for biasing said electrode to

suppress escape of secondary electrons from said Faraday cup and/or to suppress hollow cathode

discharge.

13. (Original) Plasma doping apparatus as defined in claim 1 further comprising at least

one magnet disposed at an entrance of said Faraday cup for suppressing escape of secondary

electrons from said Faraday cup.

Amendment

Serial No.: 09/836,743

Docket No.: VSEA 97-003

14. (Original) Plasma doping apparatus as defined in claim 1 wherein said Faraday cup

has an entrance having a lateral dimension, wherein the lateral dimension of said entrance is

small in comparison with a depth of said Faraday cup, and wherein a geometric configuration of

said Faraday cup suppresses escape of secondary electrons through said entrance.

15. (Original) Plasma doping apparatus as defined in claim 1 wherein said chamber has

electrically conductive walls and wherein said anode and said chamber are connected to a

common electrical potential.

16. (Original) Plasma doping apparatus as defined in claim 1 wherein said chamber

includes electrically conductive walls and wherein said anode comprises the electrically

conductive walls of said chamber.

17. (Original) Plasma doping apparatus as defined in claim 1 wherein said platen is

configured for supporting a semiconductor wafer.

18. (Original) Plasma doping apparatus as defined in claim 1 wherein said Faraday cup

comprises an entrance aperture plate defining an entrance aperture for receiving said positive

ions, an ion collector plate for collecting said positive ions, a secondary electron collector ring

disposed between said aperture plate and said ion collector plate, and means for biasing said

secondary electron collector ring at a positive potential with respect to said ion collector plate.

into the workpiece comprising the step of:

19. (Original) In plasma doping apparatus comprising a plasma doping chamber, a platen mounted in said chamber for supporting a workpiece, a source of an ionizable gas coupled to said chamber, an anode spaced from said platen and a pulse source for applying high voltage pulses between said platen and said anode for producing a plasma having a plasma sheath in the vicinity of said workpiece, said plasma containing positive ions of said ionizable gas, said high voltage pulses accelerating said positive ions across the plasma sheath toward said platen for implantation into the workpiece, a method for monitoring a dose of said positive ions implanted

collecting a sample of said positive ions accelerated across said plasma sheath with a Faraday cup positioned adjacent to said platen, said sample being representative of a number of positive ions implanted into the workpiece.

- 20. (Original) A method as defined in claim 19 wherein the step of collecting a sample of said positive ions is performed with a plurality of Faraday cups disposed around said platen.
- 21. (Original) A method as defined in claim 19 further including the step of configuring said Faraday cup so as to minimize any disturbance to said platen caused by the presence of said Faraday cup.
- 22. (Original) A method as defined in claim 19 further including the step of integrating an electrical current produced by said Faraday cup in response to said positive ions with respect to time and generating an output representative of the dose of positive ions implanted into the workpiece.

implantation into the workpiece.

23. (Original) A method as defined in claim 19 wherein the step of collecting the sample of said positive ions is performed by a plurality of Faraday cups disposed around said platen, each producing a current representative of the number of positive ions implanted into the workpiece per unit time and further including the steps of comparing the currents produced by said plurality of Faraday cups and generating an output indicative of the uniformity of ion

24. (Original) A method as defined in claim 19 further including the step of biasing an electrode positioned at an entrance of said Faraday cup to suppress escape of secondary electrons from said Faraday cup and/or to suppress hollow cathode discharge.

25. (Original) A method as defined in claim 19 wherein the step of collecting a sample of said positive ions is performed with two or more Faraday cups embedded in a guard ring disposed around said platen.

26. (Original) A method as defined in claim 19 wherein the step of collecting a sample of said positive ions is performed with an annular Faraday cup embedded in a guard ring disposed around said platen.

27. (Original) A method as defined in claim 19 wherein the step of collecting a sample of said positive ions is performed with an ion collector plate spaced from an entrance aperture in an entrance aperture plate, further comprising the step of preventing secondary electrons formed at the ion collector plate from moving toward the entrance aperture with a secondary electron collector ring positioned between the ion collector plate and the entrance aperture.

Docket No.: VSEA 97-003

28. (Original) Plasma doping apparatus comprising:

a plasma doping chamber;

a platen mounted in said plasma doping chamber for supporting a workpiece;

a source of ionizable gas coupled to said chamber, said ionizable gas containing a desired

dopant for implantation into the workpiece;

a pulse source for applying high voltage pulses between said platen and the electrically

conductive walls of said chamber for producing a plasma having a plasma sheath in the vicinity

of said workpiece, said plasma containing positive ions of said ionizable gas, said high voltage

pulses accelerating said positive ions across the plasma sheath toward said platen for

implantation into the workpiece; and

a Faraday cup positioned adjacent to said platen for collecting a sample of said positive

ions accelerated across said plasma sheath, the sample of said positive ions collected by said

Faraday cup being representative of a dose of said positive jons implanted into the workpiece.

29. (Original) Plasma doping apparatus as defined in claim 28 wherein said Faraday cup

comprises

a plurality of Faraday cups disposed around said platen.

30. (Original) Plasma doping apparatus as defined in claim 28 wherein said Faraday cup

comprises an annular Faraday cup disposed around said platen.

Amendment

Serial No.: 09/836,743 Docket No.: VSEA 97-003

generates an electrical current representative of the number positive ions implanted into the

31. (Original) Plasma doping apparatus as defined in claim 28 wherein said Faraday cup

workpiece per unit time and wherein said apparatus further comprises a dose processing circuit

for integrating said current with respect to time and generating an output representative of the

dose of positive ions implanted into the workpiece.

32. (Original) Plasma doping apparatus as defined in claim 28 wherein said Faraday cup

comprises a plurality of Faraday cups disposed around said platen, each producing a current

representative of the number of positive ions implanted into the workpiece per unit time and

wherein said plasma doping apparatus further comprises a dose uniformity circuit for comparing

the currents produced by said plurality of Faraday cups and generating in response to the

comparison an output indicative of the uniformity of ion implantation into the workpiece.

33. (Original) Plasma doping apparatus as defined in claim 28 further comprising a guard

ring disposed around said platen, wherein said Faraday cup is embedded within said guard ring.

34. (Original) Plasma doping apparatus as defined in claim 28 further comprising a

closed loop pressure control system coupled to said plasma doping chamber for controlling the

pressure of said ionizable gas in said chamber.

35. (Original) Plasma doping apparatus as defined in claim 28 wherein said Faraday cup comprises an entrance aperture plate defining an entrance aperture for receiving said positive ions, an ion collector plate for collecting said positive ions, a secondary electron collector ring disposed between said aperture plate and said ion collector plate, and means for biasing said secondary electron collector ring at a positive potential with respect to said ion collector plate.

- 36. (Original) Plasma doping apparatus comprising:
- a plasma doping chamber;
- a platen mounted in said plasma doping chamber for supporting a workpiece, said workpiece constituting a cathode;

an anode spaced from said platen;

a source of ionizable gas coupled to said chamber, said gas containing a desired dopant for implantation into the workpiece;

means for producing a plasma containing positive ions of said ionizable gas between said platen and said anode;

a pulse source for applying high voltage pulses between said platen and said anode for accelerating said positive ions across a plasma sheath of said plasma toward said platen for implantation into the workpiece; and

a Faraday cup positioned adjacent to said platen for collecting a sample of said positive ions accelerated across said plasma sheath, said sample being representative of the dose of positive ions implanted into the workpiece.

37. (Original) Plasma doping apparatus as defined in claim 36 wherein said Faraday cup comprises a plurality of Faraday cups disposed around said platen.

Amendment

Serial No.: 09/836,743

Docket No.: VSEA 97-003

38. (Original) Plasma doping apparatus as defined in claim 36 wherein said Faraday cup

comprises an annular Faraday cup disposed around said platen.

39. (Original) Plasma doping apparatus as defined in claim 36 further comprising a guard

ring disposed around said platen, wherein said Faraday cup is embedded within said guard ring.

40. (Original) Plasma doping apparatus as defined in claim 36 wherein said Faraday cup

comprises an entrance aperture plate defining an entrance aperture for receiving said positive

ions, an ion collector plate for collecting said positive ions, a secondary electron collector ring

disposed between said aperture plate and said ion collector plate, and means for biasing said

secondary electron collector ring at a positive potential with respect to said ion collector plate.

Cancel Claim 41.

Cancel Claim 42.

Cancel Claim 43.

Cancel Claim 44.

Cancel Claim 45.

Cancel Claim 46.